



SANYO Semiconductors

DATA SHEET

SCH2807 —

MOSFET : N-Channel Silicon MOSFET

SBD : Schottky Barrier Diode

General-Purpose Switching Device Applications

Features

- Composite type with an N-channel silicon MOSFET (SCH1407) and a schottky barrier diode (SS05015) contained in one package facilitating high-density mounting.

[MOSFET]

- Low ON-resistance.
- Ultrahigh-speed switching.
- 4V drive.

[SBD]

- Short reverse recovery time.
- Low forward voltage.

Specifications

Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
[MOSFET]				
Drain-to-Source Voltage	V _{DSS}		20	V
Gate-to-Source Voltage	V _{GSS}		±15	V
Drain Current (DC)	I _D		1.2	A
Drain Current (Pulse)	I _{DP}	PW≤10μs, duty cycle≤1%	4.8	A
Allowable Power Dissipation	P _D	Mounted on a ceramic board (900mm ² ×0.8mm) 1unit	0.6	W
Channel Temperature	T _{ch}		150	°C
Storage Temperature	T _{stg}		-55 to +125	°C
[SBD]				
Repetitive Peak Reverse Voltage	V _{RRM}		15	V
Nonrepetitive Peak Reverse Surge Voltage	V _{RSM}		15	V
Average Output Current	I _O		0.5	A
Surge Forward Current	I _{FSM}	50Hz sine wave, 1 cycle	3	A
Junction Temperature	T _j		-55 to +125	°C
Storage Temperature	T _{stg}		-55 to +125	°C

Marking : QG

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SCH2807

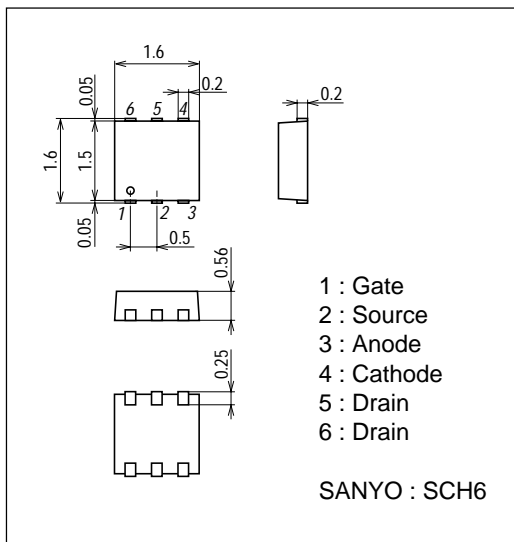
Electrical Characteristics at Ta=25°C

Parameter	Symbol	Conditions	Ratings			Unit
			min	typ	max	
[MOSFET]						
Drain-to-Source Breakdown Voltage	$V_{(BR)DSS}$	$I_D=1mA, V_{GS}=0$	20			V
Zero-Gate Voltage Drain Current	I_{DSS}	$V_{DS}=20V, V_{GS}=0$			1	μA
Gate-to-Source Leakage Current	I_{GSS}	$V_{GS}=\pm 12V, V_{DS}=0$			± 10	μA
Cutoff Voltage	$V_{GS(off)}$	$V_{DS}=10V, I_D=1mA$	1.2		2.6	V
Forward Transfer Admittance	$ y_{fs} $	$V_{DS}=10V, I_D=600mA$	480	800		mS
Static Drain-to-Source On-State Resistance	$R_{DS(on)1}$	$I_D=600mA, V_{GS}=10V$		240	320	$m\Omega$
	$R_{DS(on)2}$	$I_D=300mA, V_{GS}=4.5V$		480	675	$m\Omega$
	$R_{DS(on)3}$	$I_D=300mA, V_{GS}=4V$		590	830	$m\Omega$
Input Capacitance	C_{iss}	$V_{DS}=10V, f=1MHz$		38		pF
Output Capacitance	C_{oss}	$V_{DS}=10V, f=1MHz$		13.5		pF
Reverse Transfer Capacitance	C_{rss}	$V_{DS}=10V, f=1MHz$		9.2		pF
Turn-ON Delay Time	$t_{d(on)}$	See specified Test Circuit.		5.0		ns
Rise Time	t_r	See specified Test Circuit.		16.0		ns
Turn-OFF Delay Time	$t_{d(off)}$	See specified Test Circuit.		9.4		ns
Fall Time	t_f	See specified Test Circuit.		3.4		ns
Total Gate Charge	Q_g	$V_{DS}=10V, V_{GS}=10V, I_D=1.2A$		2.1		nC
Gate-to-Source Charge	Q_{gs}	$V_{DS}=10V, V_{GS}=10V, I_D=1.2A$		0.6		nC
Gate-to-Drain "Miller" Charge	Q_{gd}	$V_{DS}=10V, V_{GS}=10V, I_D=1.2A$		0.2		nC
Diode Forward Voltage	V_{SD}	$I_S=1.2A, V_{GS}=0$		0.92	1.2	V
[SBD]						
Reverse Voltage	V_R	$I_R=0.5mA$	15			V
Forward Voltage	V_F	$I_F=0.5A$		0.4	0.46	V
Reverse Current	I_R	$V_R=6V$			90	μA
Interterminal Capacitance	C	$V_R=10V, f=1MHz$		13		pF
Reverse Recovery Time	t_{rr}	$I_F=I_R=100mA$, See specified Test Circuit.			10	ns

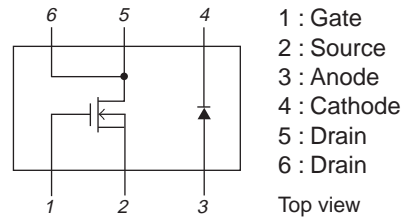
Package Dimensions

unit : mm

2230A



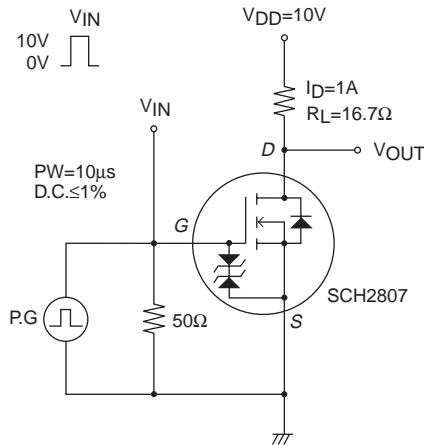
Electrical Connection



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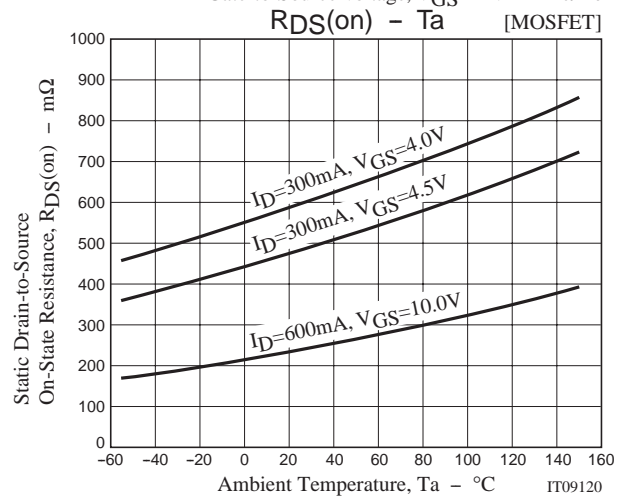
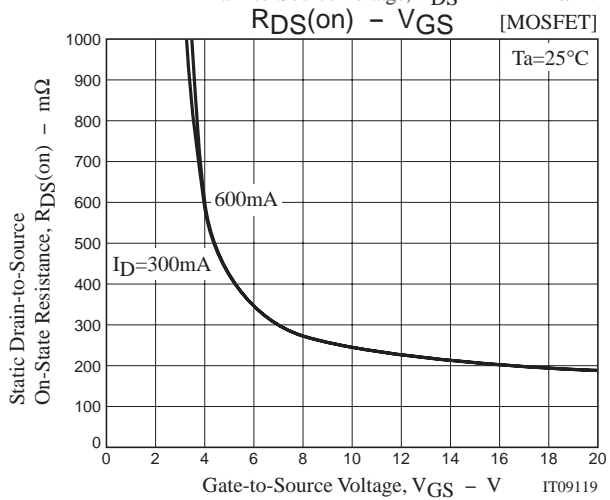
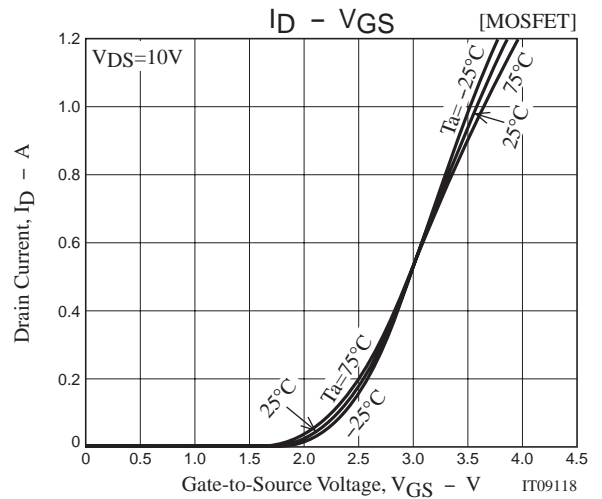
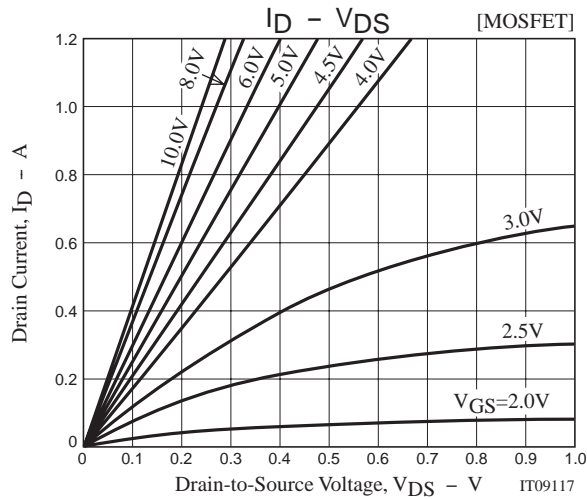
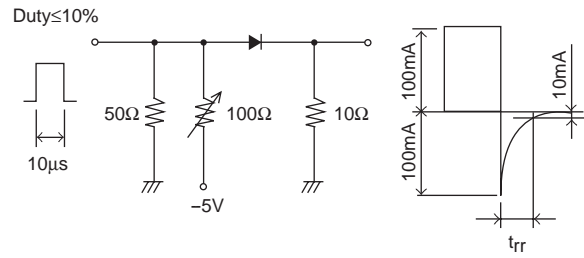
Switching Time Test Circuit

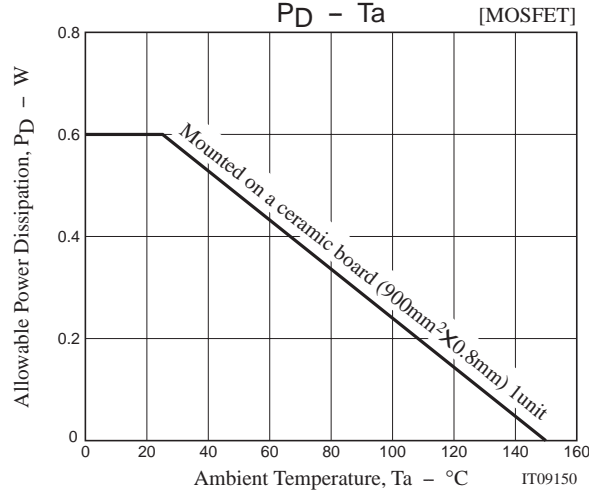
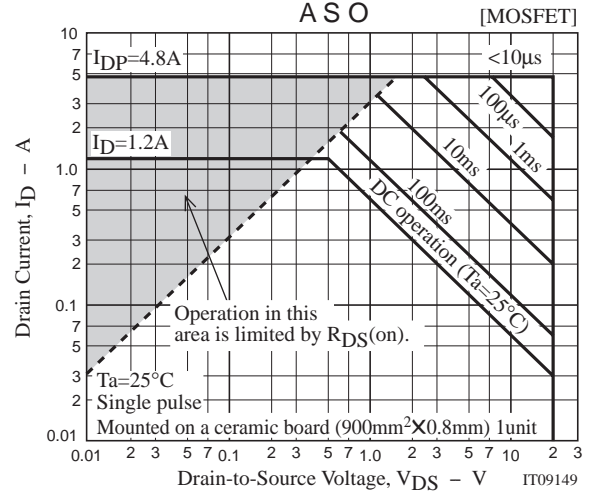
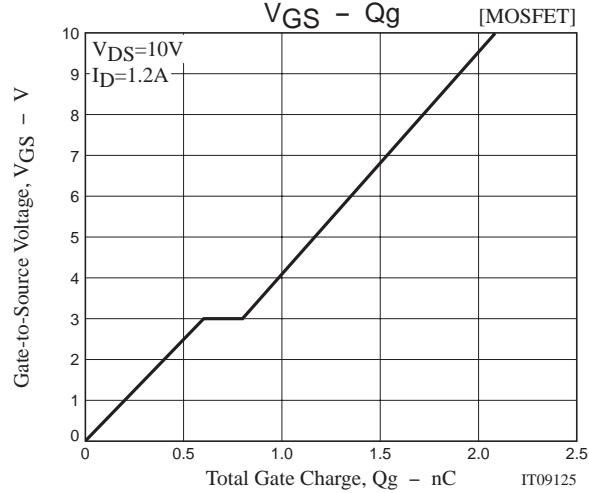
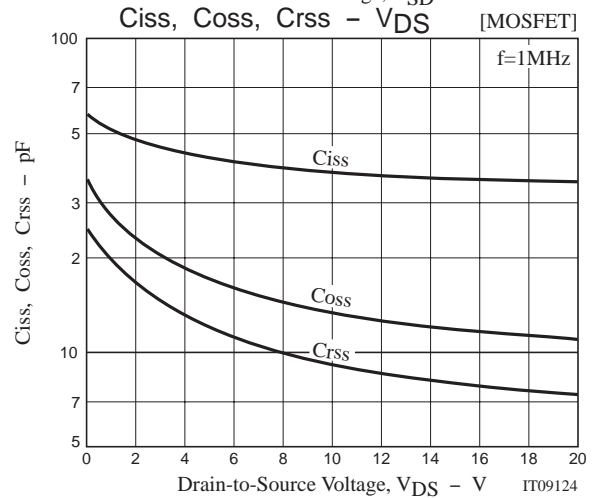
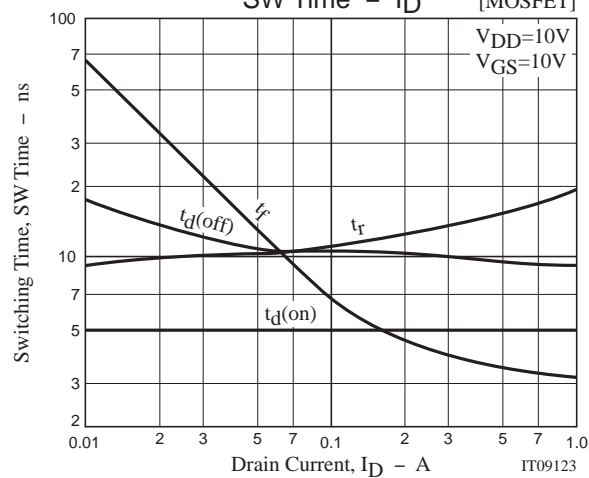
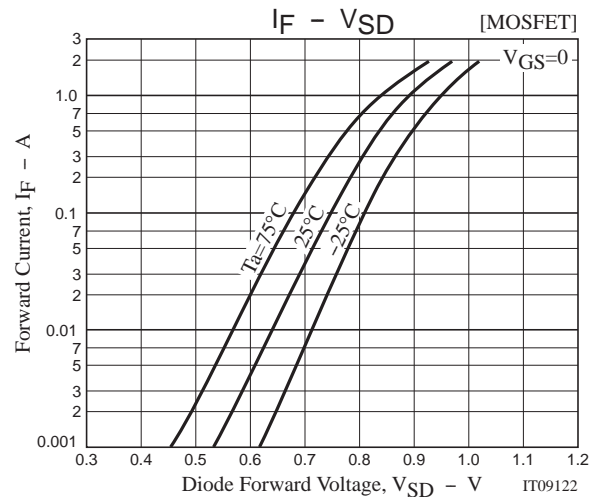
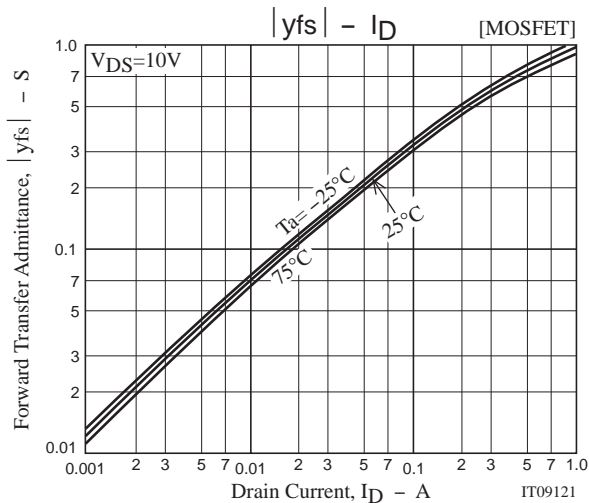
[MOSFET]

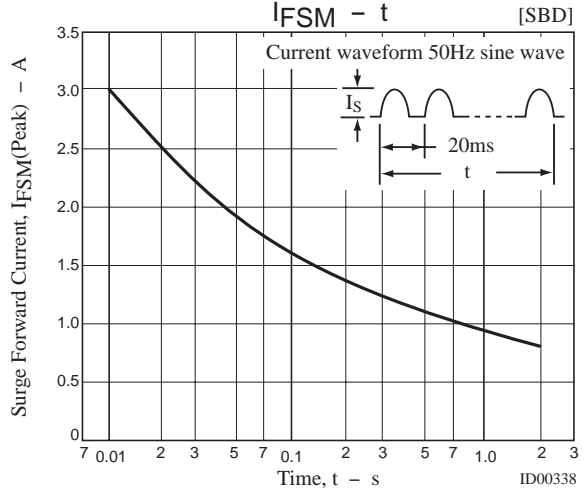
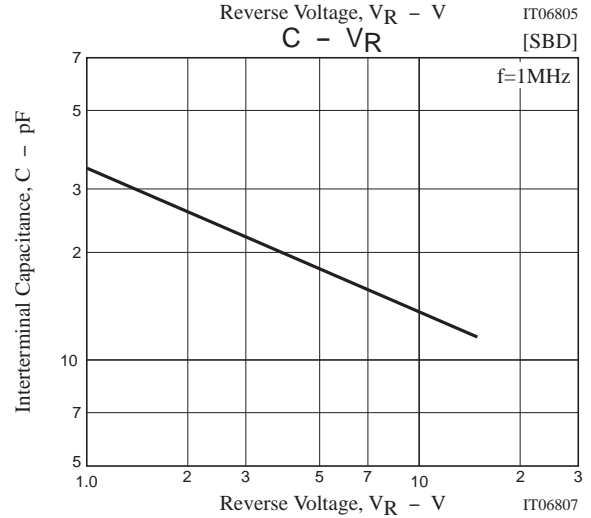
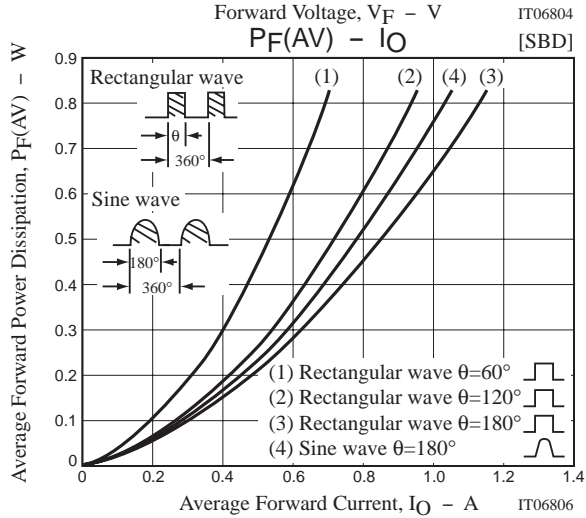
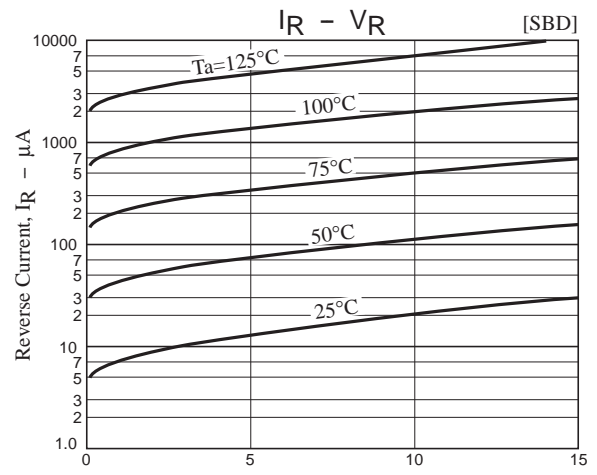
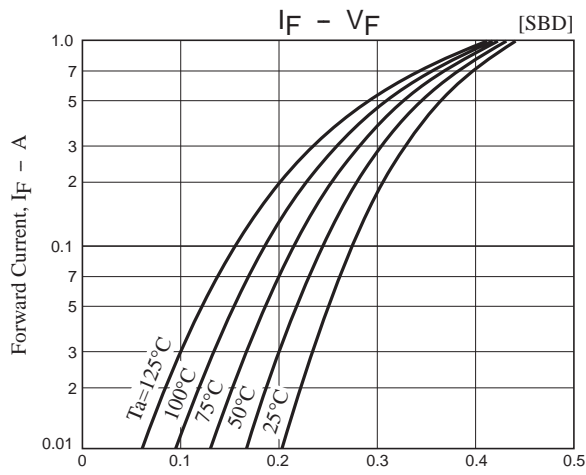


t_{rr} Test Circuit

[SBD]







Note on usage : Since the SCH2807 is a MOSFET product, please avoid using this device in the vicinity of highly charged objects.

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